

BB02-UH: 3.96mm (0.156") HEADER, RIGHT ANGLE, SINGLE ROW, THROUGH HOLE - 02 to 24 CONTACTS

SPECIFICATIONS

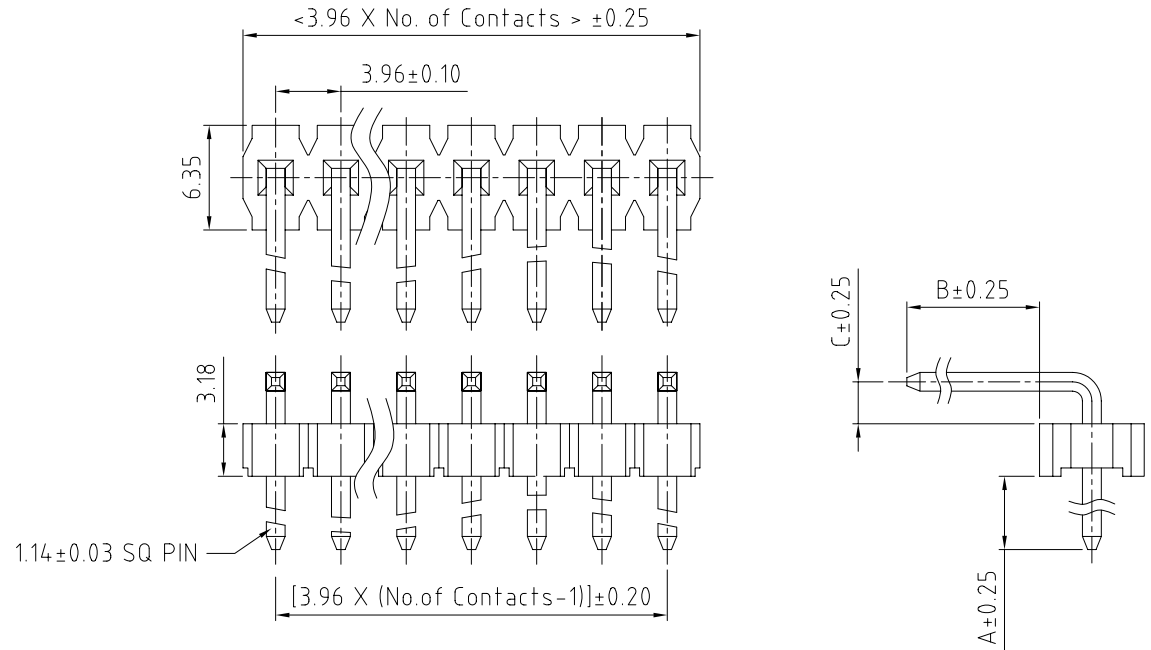
CURRENT RATING	7.9 AMP
INSULATOR RESISTANCE	5000 MEGOHMS MIN.
CONTACT RESISTANCE	20m ohms MAX.
DIELECTRIC WITHSTANDING	1500V AC/DC
OPERATING TEMPREATURE	-55°C TO +105°C
CONTACT MATERIAL	BRASS
INSULATOR MATERIAL	LCP, UL 94V-0
PLATING	MATT TIN OVER 30-50U" NICKEL
SOLDERABILITY	IR REFLOW: 280°C FOR 10 SEC WAVE: 250°C FOR 5-10 SEC MANUAL SOLDER: 380°C FOR 3-5 SEC

PACKAGE: BULK.

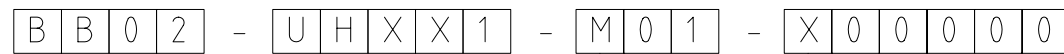
MATES WITH: - BB02-US
BB02-UT

NOTES:

- GOLD FLASH PLATING IS AVAILABLE UPON REQUEST, PLEASE CONTACT US FOR MORE INFORMATION.



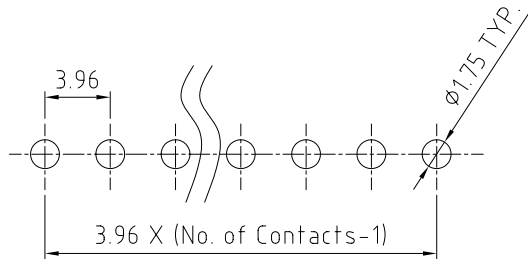
HOW TO ORDER



NO. OF CONTACTS
02 TO 24

CONTACT PLATING OPTIONS
M = MATT TIN (STANDARD)

A = A : 4.45, B : 8.15, C : 2.55
B = A : 4.00, B : 13.60, C : 4.95
C = A : 4.50, B : 10.75, C : 6.30
D = A : 3.66, B : 3.66, C : 2.87 Δ
E = A : 4.00, B : 6.00, C : 1.15 Δ
F = A : 4.45, B : 6.00, C : 2.55 Δ
G = A : 4.00, B : 17.80, C : 2.90 Δ



(TOLERANCE: ± 0.05)

RECOMMENDED PC BOARD LAYOUT

REV. DATE & DPN	10. 15/06/07 - CHC RELEASE
11. 07/06/08 - CHC	11. ADD PIN LENGTH OPTIONS D
12. 06/06/08 - CHC	12. PLATING MODIFICATION
13. 04/07/08 - CHC	13. ADD PIN LENGTH OPTIONS E
14. 08/07/08 - CHC	14. ADD PIN LENGTH OPTIONS F
15. 12/25/08 - NYW	15. ADD PIN LENGTH OPTIONS G
16. 06/03/09 - NYW	16. DRAWING MODIFICATION
	REMOVE OTHER PLATING OPTIONS. ADD NOTES 1.

Scale: 3:1	THIRD ANGLE	Unstated Tolerances: X ± 0.30 X ± 0.25 XX ± 0.15 XXX ± 0.10	Material SEE NOTE
Drawn: CHC			
App'd: XXXX	Title: HEADER		NOT TO SCALE
Date: 6 MAR '09	Revision: 1.6		Unit: mm

GRADConn
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Type: BB02-UH
BB02-UH
Drawing Number:
Sheet 1 of 1
Drawing © E and O E